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Design and Verification of Low-Power Integrated Circuits

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DESIGN AND
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IEEE Std	FDIS	Report on voting
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Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

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IEEE Standard for Design and Verification of Low-Power Integrated Circuits

Sponsor

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Grateful acknowledgment is made to the following for permission to use source material:

Accellera Systems Initiative
      Unified Power Format (UPF) Standard, Version 1.0

Cadence Design Systems, Inc.
      Library Cell Modeling Guide Using CPF
      Hierarchical Power Intent Modeling Guide Using CPF

Silicon Integration Initiative, Inc.
      Si2 Common Power Format Specification, Version 2.0

Abstract: A method is provided for specifying power intent for an electronic design, for use in verification of the structure and behavior of the design in the context of a given power management architecture, and for driving implementation of that power management architecture. The method supports incremental refinement of power intent specifications required for IP-based design flows.
Keywords: corruption semantics, IEEE 1801™, interface specification, IP reuse, isolation, level-shifting, power-aware design, power domains, power intent, power modes, power states, progressive design refinement, retention, retention strategies

IEEE Introduction

This introduction is not part of IEEE Std 1801-2013, IEEE Standard for Design and Verification of Low-Power Integrated Circuits.

The purpose of this standard is to provide portable low-power design specifications that can be used with a variety of commercial products throughout an electronic system design, analysis, verification, and implementation flow.

When the electronic design automation (EDA) industry began creating standards for use in specifying, simulating, and implementing functional specifications of digital electronic circuits in the 1980s, the primary design constraint was the transistor area necessary to implement the required functionality in the prevailing process technology at that time. Power considerations were simple and easily assumed for the design as power consumption was not a major consideration and most chips operated on a single voltage for all functionality. Therefore, hardware description languages (HDLs) such as VHDL (IEC 61691-1-1/ IEEE Std 1076™)[a] and SystemVerilog (IEEE Std 1800™) provided a rich set of capabilities necessary for capturing the functional specification of electronic systems, but no capabilities for capturing the power architecture (how each element of the system is to be powered).

As the process technology for manufacturing electronic circuits continued to advance, power (as a design constraint) continually increased in importance. Even above the 90 nm process node size, dynamic power consumption became an important design constraint as the functional size of designs increased power consumption at the same time battery-operated mobile systems, such as cell phones and laptop computers, became a significant driver of the electronics industry. Techniques for reducing dynamic power consumption—the amount of power consumed to transition a node from a 0 to 1 state or vice versa— became commonplace. Although these techniques affected the design methodology, the changes were relatively easy to accommodate within the existing HDL-based design flow, as these techniques were primarily focused on managing the clocking for the design (more clock domains operating at different frequencies and gating of clocks when logic in a clock domain is not needed for the active operational mode). Multi-voltage power-management methods were also developed. These methods did not directly impact the functionality of the design, requiring only level-shifters between different voltage domains. Multi-voltage power domains could be verified in existing design flows with additional, straight-forward extensions to the methodology.

With process technologies below 100 nm, static power consumption has become a prominent and, in many cases, dominant design constraint. Due to the physics of the smaller process nodes, power is leaked from transistors even when the circuitry is quiescent (no toggling of nodes from 0 to 1 or vice versa). New design techniques were developed to manage static power consumption. Power gating or power shut-off turns off power for a set of logic elements. Back-bias techniques are used to raise the voltage threshold at which a transistor can change its state. While back bias slows the performance of the transistor, it greatly reduces leakage. These techniques are often combined with multi-voltages and require additional functionality: power-management controllers, isolation cells that logically and/or electrically isolate a shutdown power domain from "powered-up" domains, level-shifters that translate signal voltages from one domain to another, and retention registers to facilitate fast transition from a power-off state to a power-on state for a domain.

The EDA industry responded with multiple vendors developing proprietary low-power specification capabilities for different tools in the design and implementation flow. Although this solved the problem locally for a given tool, it was not a global solution in that the same information was often required to be specified multiple times for different tools without portability of the power specification. At the Design

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[a]Information on references can be found in Clause 2.

Automation Conference (DAC) in June 2006, several semiconductor/electronics companies challenged the EDA industry to define an open, portable power specification standard. The EDA industry standards incubation consortium, Accellera Systems Initiative, answered the call by creating a Technical SubCommittee (TSC) to develop a standard. The effort was named Unified Power Format (UPF) to recognize the need of unifying the capabilities of multiple proprietary formats into a single industry standard. Accellera approved *UPF 1.0* as an Accellera standard in February 2007. In May 2007, Accellera donated UPF to the IEEE for the purposes of creating an IEEE standard, and in March 2009, the first version of the IEEE Std 1801 was released. So this standard, although the second version of the IEEE Std 1801, represents the third version of what is more colloquially referred to as UPF.

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1. Overview

1.1 Scope

This standard establishes a format used to define the low-power design intent for electronic systems and electronic intellectual property (IP). The format provides the ability to specify the supply network, switches, isolation, retention, and other aspects relevant to power management of an electronic system. The standard defines the relationship between the low-power design specification and the logic design specification captured via other formats [e.g., standard hardware description languages (HDLs)].

1.2 Purpose

The standard provides portability of low-power design specifications that can be used with a variety of commercial products throughout an electronic system design, analysis, verification, and implementation flow.

1.3 Key characteristics of the Unified Power Format

The Unified Power Format (UPF) provides the ability for electronic systems to be designed with power as a key consideration early in the process. UPF accomplishes this by allowing the specification of what was traditionally physical implementation-based power information early in the design process—at the register transfer level (RTL) or earlier. Figure 1 shows UPF supporting the entire design flow. UPF provides a

consistent format to specify power design information that may not be easily specifiable in an HDL or when it is undesirable to directly specify the power semantics in an HDL, as doing so would tie the logic specification directly to a constrained power implementation. UPF specifies a set of HDL attributes and HDL packages to facilitate the expression of power intent in HDL when appropriate (see Table 4 and Annex B). UPF also defines consistent semantics across verification and implementation, i.e., what is implemented is the same as what has been verified.
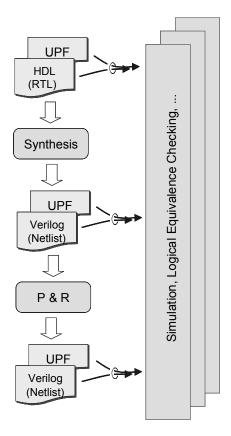
Figure 1—UPF tool flow

As indicated in Figure 1, UPF files are part of the design source and, when combined with the HDL, represent a complete design description: the HDL describing the logical intent and the UPF describing the power intent. Combined with the HDL, the UPF files are used to describe the intent of the designer. This collection of source files is the input to several tools, e.g., simulation tools, synthesis tools, and formal verification tools. UPF supports the successive refinement methodology (see 4.8) where power intent information will grow along the design flow to provide needed information for each design stage.

— Simulation tools can read the HDL/UPF design input files and perform RTL power-aware simulation. At this stage, the UPF may only contain abstract models such as power domains and supply sets without the need to create the power and ground network and implementation details.

— Synthesis tools can read the HDL/UPF design input files and produce a netlist. The tool or user may produce a new UPF fileset that, combined with the netlist, represents a further refined version of same design.

— In those cases where design object names change, a UPF file with the new names is needed. A UPF-aware logical equivalence checker can read the full design and UPF filesets and perform the checks to ensure power-aware equivalence.

— Place and route tools read both the netlist and the UPF files and produce a physical netlist, potentially including an output UPF file.

UPF is a concise power intent specification capability. Power intent can be easily specified over many elements in the design. A UPF specification can be included with the other deliverables of IP blocks and reused along with the other delivered IP. UPF supports various methodologies through carefully defined semantics, flexibility in specification, and, when needed, defined rational limitations that facilitate automation in verification and implementation (see Annex E).

A *UPF specification* defines how to create a supply network to supply power to each instance, how the individual supply nets behave with respect to one another, and how the logic functionality is extended to support dynamic power switching to these logic instances. By controlling the states and voltages of the supplies provided to the supply network, and by controlling the states of power switches that are part of the supply network, the power management logic of a system can cause each functional region to receive the power required to complete its computational tasks in a timely manner.

1.4 Use of color in this standard

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— Cross references that are hyperlinked to other portions of this standard are shown in underlined-blue text (hyperlinking works when this standard is viewed interactively as a PDF file).

— Syntactic keywords and tokens in the formal language definitions are shown in **boldface-red text**.

— Command arguments that can be provided incrementally (*layered*) are shown in **boldface-green text**. See also 5.11.

— Syntactic keywords and tokens that have been explicitly identified as legacy or deprecated constructs (see 6.1) may be shown in **brown text**.

1.5 Contents of this standard

The organization of the remainder of this standard is as follows:

— Clause 2 provides references to other applicable standards that are presumed or required for this standard.

— Clause 3 defines terms and acronyms used throughout the different specifications contained in this standard.

— Clause 4 describes the basic concepts underlying UPF.

— Clause 5 describes the language basics for UPF and its commands.

— Clause 6 details the syntax and semantics for each UPF power intent command.

— Clause 7 details the syntax and semantics for each UPF power-management cell command.

— Clause 8 defines a reference model for UPF command processing.

— Clause 9 defines simulation semantics for various UPF commands.

— Annexes. Following Clause 9 are a series of annexes.

2. Normative references

The following referenced documents are indispensable for the application of this standard (i.e., they must be understood and used, so each referenced document is cited in the text and its relationship to this document is explained). For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments or corrigenda) applies.

IEC 61691-1-1/IEEE Std 1076™, Behavioural languages—Part 1: VHDL Language Reference Manual.[1, 2]

IEEE Std 1800™, IEEE Standard for SystemVerilog—Unified Hardware Design, Specification, and Verification Language.[3]

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